

Product Features:

Low Cost SMD Package Low ESR Compatible with Leadfree Processing

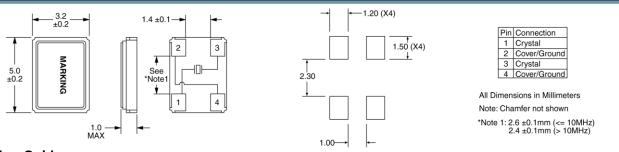
Applications:

Fibre Channel Server & Storage Sonet / SDH 802.11 / WiFi T1/E1, T3/E3

Electrical Specifications

Frequency	8MHz to 150MHz
Equivalent Series Resistance	
8MHz – 9.999999MHz	100 Ohms Maximum
10MHz – 11.999999MHz	80 Ohms Maximum
12MHz – 15.999999MHz	60 Ohms Maximum
16MHz – 19.999999MHz	50 Ohms Maximum
20MHz – 23.999999MHz	40 Ohms Maximum
24MHz – 50MHz	30 Ohms Maximum
30MHz – 150MHz (Third Overtone)	80 Ohms Maximum
Shunt Capacitance (C0)	5pF Maximum
Frequency Tolerance (at 25°C)	±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm
Frequency Stability (over Temperature)	±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm
Mode of Operation	
8MHz – 50MHz	Fundamental
30MHz – 150MHz	Third Overtone
Crystal Cut	AT Cut
Load Capacitance	8pF to 32pF or Specify
Drive Level	100μW Maximum
Aging	±5ppm/Year Maximum
Operating Temperature Range	See Part Number Guide
Storage Temperature Range	-40°C to +85°C

Mechanical and Solder Pad Dimensions



Part Number Guide

	Sample Part Number: ILCX07 - FB1F18 - 20.000 MHz					
Package	Frequency Tolerance	Frequency Stability	Operating Temperature Range	Mode of Operations	Load Capacitance	Frequency
	B = ±50ppm	B = ±50ppm	0 = 0°C to +50°C	F = Fundamental		00 000 MU-
	F = ±30ppm	F = ±30ppm	1 = 0°C to +70°C	3 = Third Overtone		
G :	G = ±25ppm	G = ±25ppm	2 = -10°C to +60°C			
II 0V07	H = ±20ppm	H = ±20ppm	3 = -20°C to +70°C			
ILCX07 - I = ±15ppm	I = ±15ppm*, **	5 = -40°C to +85°C	8pF to 32pF or Specify	20.000 MHz		
	$J = \pm 10 \text{ppm}^*$ $J = \pm 10 \text{ppm}^*, **$ $9 = -10^{\circ}\text{C to } + 50^{\circ}\text{C}$					
		D = -10°C to +105°C*				
		E = -40°C to +105°C*				

^{*} Not available at all frequencies. ** Not available for all temperature ranges.

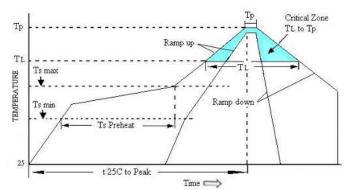








Pb Free Solder Reflow Profile:



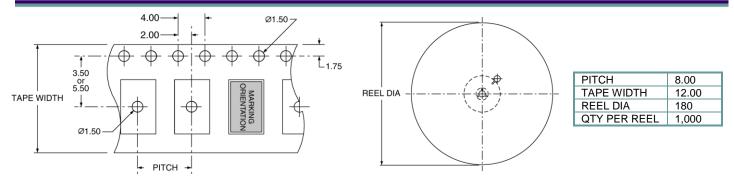
Units are backward	compatible with +240°C	reflow processes

To many to T. (Domes via Dota)	200 /
Ts max to T _L (Ramp-up Rate)	3°C / second max
Preheat	
Temperature min (Ts min)	150°C
Temperature typ (Ts typ)	175°C
Temperature max (Ts max)	200°C
Time (Ts)	60 to 180 seconds
Ramp-up Tate (T _L to Tp	3°C / second max
Time Maintained Above	
Temperature (T _L)	217°C
Time (T _{L)}	60 to 150 seconds
Deals Terraneurs (Te)	260°C max for 10
Peak Temperature (Tp)	seconds
Time within 5°C to Peak	20 to 40 seconds
Temperature (Tp)	ZU IU 40 Seconds
Ramp-down Rate	6°C / second max
Tune 25°C to Peak Temperature	8 minutes max

Package Information:

MSL = 1 (package does not contain plastic, storage life is unlimited under normal room conditions) Termination = e4 (Au over Ni over W base metallization)

Tape and Reel Information:



All Dimensions in Millimeters

Environmental Specifications:

Mechanical Shock	MIL-STD-202, Method 213
Vibration	MIL-STD-202, Method 204
Resistance to Soldering Heat	MIL-STD-202, Method 210
Solderability	J-STD-002
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2

Marking:

Line 1: ILSI, Date Code (YWW)

Line 2: Frequency